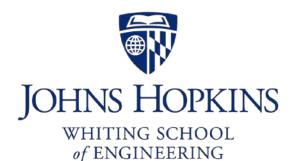
Brazing Dissimilar Metals with a Novel Composite Foil

PI - Timothy P. Weihs June 12, 2015



Project ID LM098

This presentation does not contain any proprietary, confidential, or otherwise restricted information.

Overview



- Start date: September 1, 2013
- End date: August 30, 2017
- Percent complete: 25%

Barrier

 Joining and assembly. Highvolume, high-yield joining technologies for lightweight and dissimilar materials need further improvement.

Budget

- Project budget: \$595,520
 - Budget Period 1: \$144,860
 - Budget Period 2: \$149,167

Project Partners

 Dr. Karsten Woll (former postdoc)

 now with Karlsruhe Institute of Technology, Karlsruhe, Germany



Overall Objective: Develop and characterize novel reactive foils based on reduction-oxidation (Redox) reactions for use in bonding dissimilar materials

Achievements for FY2014:

- Mechanically fabricated 23 Cu-based and Ni-based Redox Foil systems representing 11 unique chemistries
- Determined baseline strengths for bonding aluminum 6061, magnesium AZ31, aluminum coated boron steel (ACBS), and hot stamped boron steel (HSBS) with Al:CuO-based, Al:Cu₂O-based and Al:NiO-based Redox Foils, that were fabricated using initial techniques.
- Minimized mass ejection from Redox Foils more than 10x through dilution

Milestones



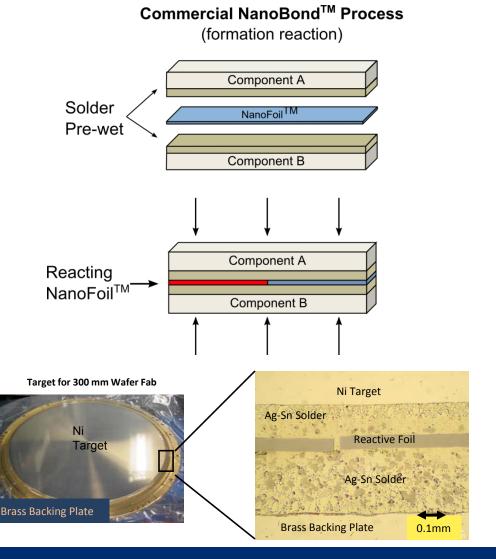
Target Date	Milestones and Go/No-Go decisions	Status
9/30/2015 ^{a,b}	Optimize Redox Foil chemistries and dilutions	On Track
9/30/2015ª	Optimize microstructures of Redox Foils	On Track
3/31/2016ª	Optimize mechanical fabrication of Redox Foils	On Track
9/30/2016 ^{a,b}	Determine critical applied pressure for bonding	pending
9/30/2016 ^{a,b}	Identify range of acceptable Redox Foil thickness	pending
12/31/2016 ^{a,c}	Optimize surface preparation methods	pending
12/31/2017	Determine bond strengths and failure modes	pending
9/30/2017	Determine corrosion behavior of optimized bonds	pending
12/31/2017	Determine microstructure/degradation near bonds	pending

^a Represents Go/No Go Decision; ^b10 MPa bond strength is needed; ^c20 MPa

6/12/15

Approach – Existing Technology

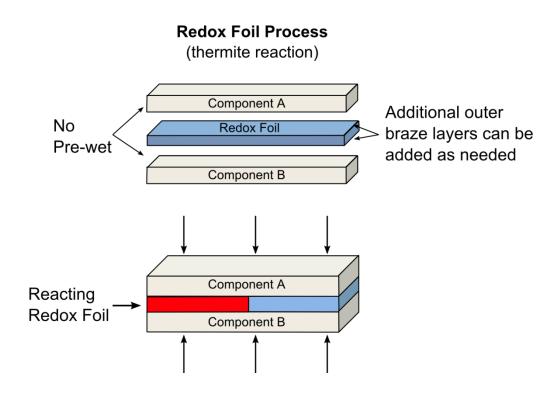
- Reactive joining has been commercialized with Al/Ni formation reactions.
 - NanoBond[™] process
 - NanoFoil[™] (Ni/Al Foils)
 - Local heat source
 - No thermal damage
- Requires pre-wet solder layer
- Expensive due to vapor phase processing of foils





Approach – Propose Technology

- Joining with Redox Foil
 - Exothermic reaction creates its own braze
 - Little thermal damage (HAZ)
 - Propagates ~0.1 m/s
- Can bond dissimilar metals
 - Ex. Steel to Mg
- Mechanical Fabrication
 - Cheaper than vapor phase processed reactive materials
 - High volume production of Redox foils can be enabled



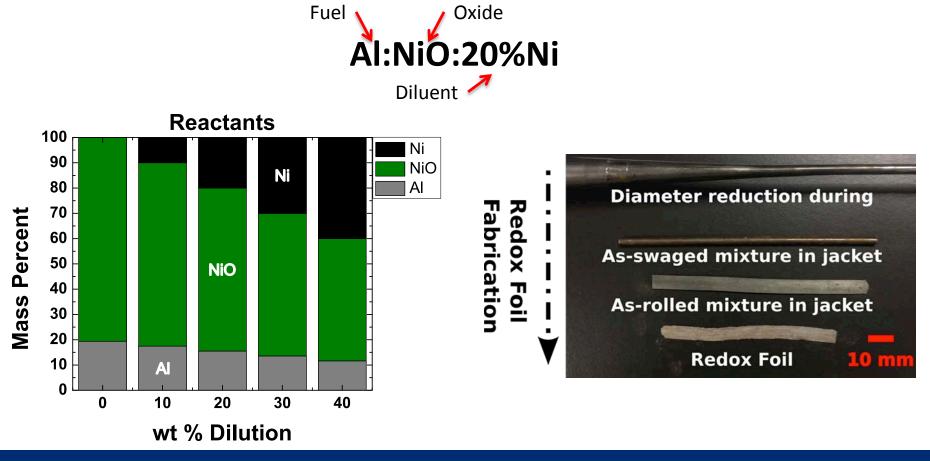
 $Al + MO + \text{dilution} \rightarrow Al_2O_3 + (M + \text{dilution}) + \text{heat}$



Technical Progress: Fabrication

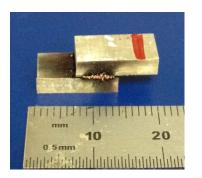


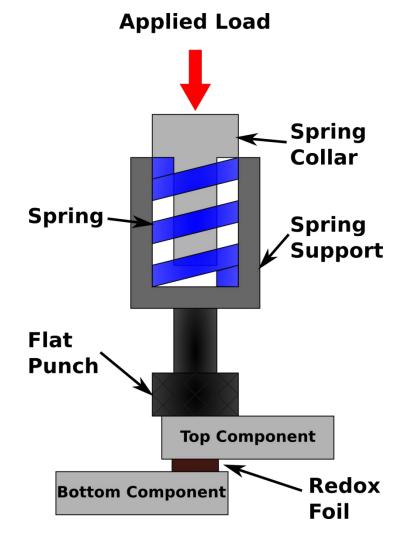
 Redox Foils fabricated by consolidating and processing (swaging and rolling) micron sized powders



Technical Progress: Bonding Parameters

- Constant pressure
 - 13 MPa
 - Maintained by spring
- 400 µm thick foils
- Foils spark ignited outside of bond area
- Base components
 - Al 6061
 - Mg AZ31
 - Al coated boron steel (ACBS)
 - Hot stamped boron steel (HSBS)



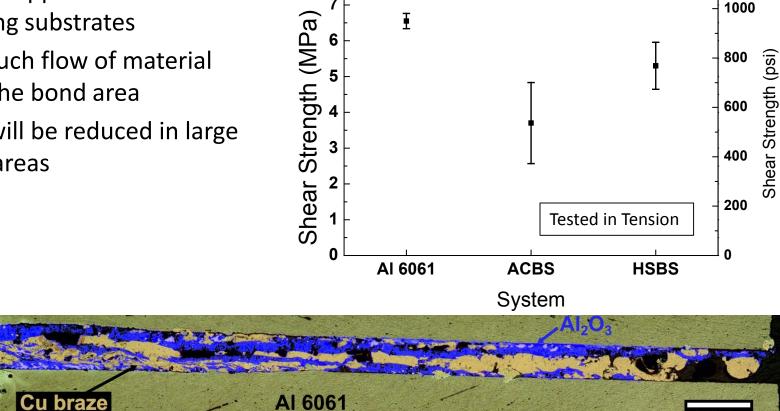




500 um

Technical Progress: Bond Strengths

- Copper appears to wet bonding substrates
- Too much flow of material from the bond area
- Flow will be reduced in large bond areas



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Al:CuO:40%Cu (400 μm thick)

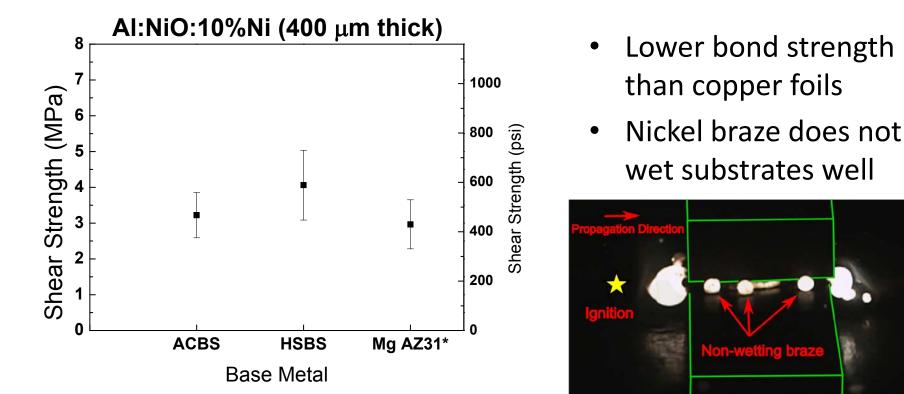
Al:CuO:40%Cu on Al 6061





Technical Progress: Bond Strengths



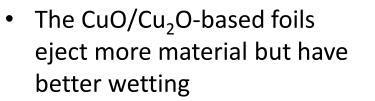




Al:NiO:10%Ni on Al 6061

Technical Progress: Fracture Surfaces

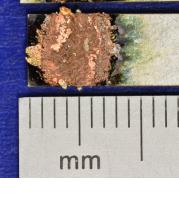
Substrate visible after fracture in bond interface

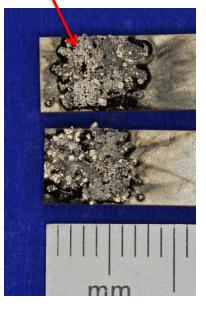


- The NiO-based Redox Foils eject less material but have poor wetting
- Strategy: dilute to minimize mass ejection and then alloy to maximize wetting and minimize corrosion

Al:CuO:40%Cu spreads on both surfaces, fracture within braze

Al:NiO:10%Ni leaves porous braze, fracture at substrate interface



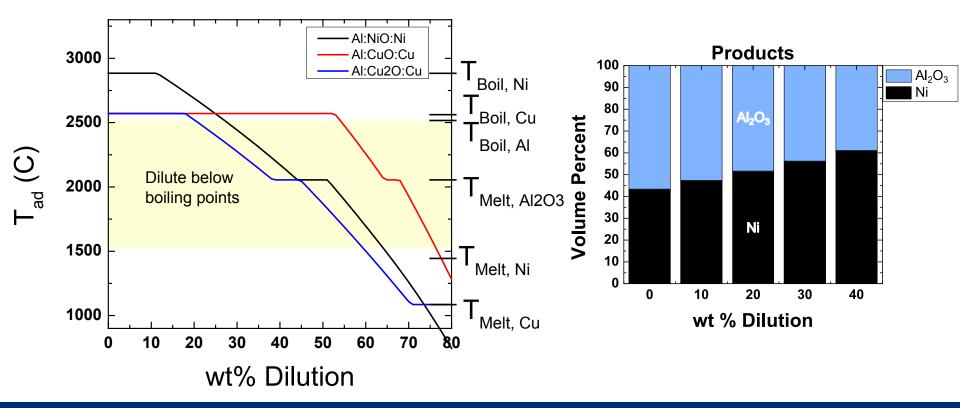




Technical Progress: Dilution



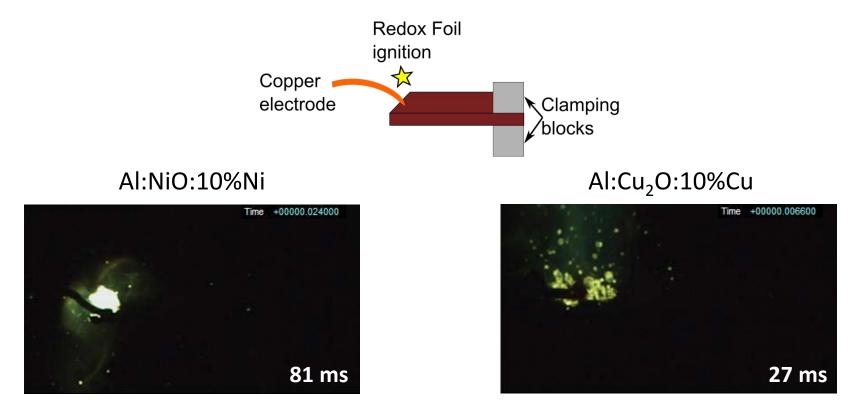
- Dilute foils enough to bring temperature of reaction below boiling points of products (and reactants)
- Dilution provides additional braze material



Technical Progress: Propagation

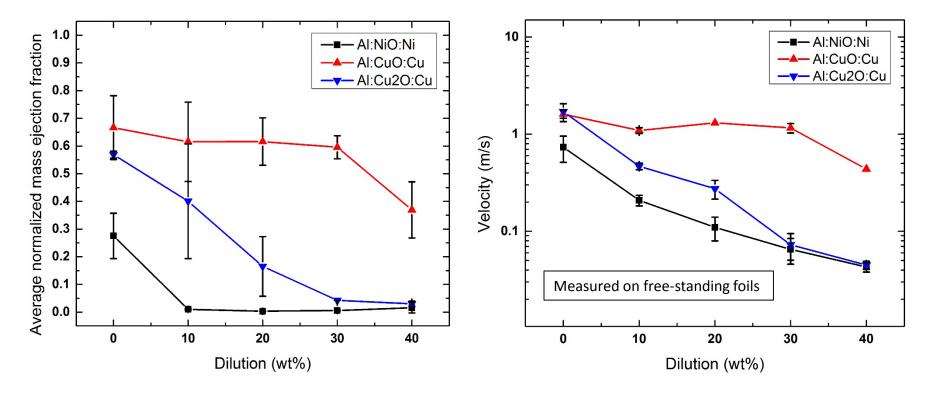


 Mass ejections and propagation velocity depend on chemistry and dilution



Technical Progress: Foil Characterization

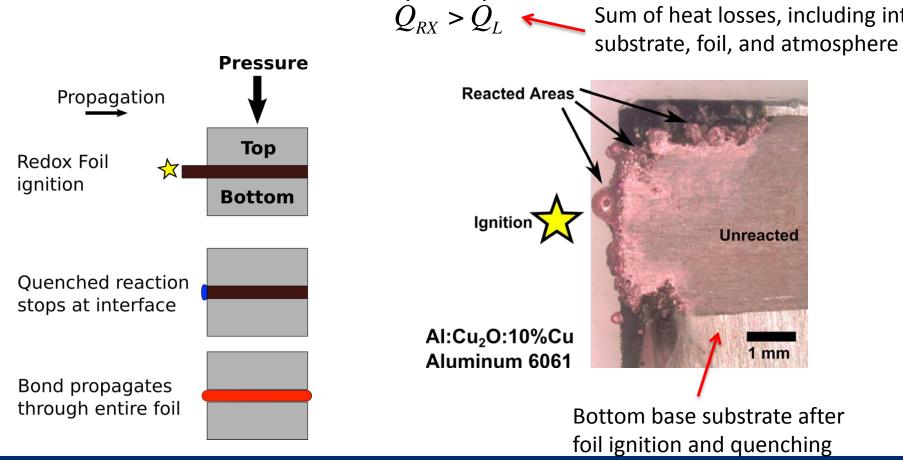
- As dilution increases, normalized mass ejection and velocity decrease
- Can mass ejection be eliminated without quenching?





Technical Progress: Quenching in Bonds

Foils must generate heat faster than heat is dissipated into surroundings or else the reaction will quench



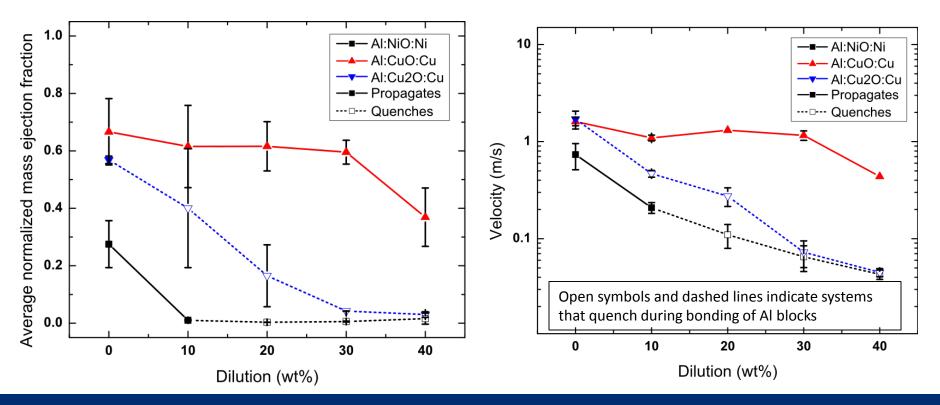


Sum of heat losses, including into

Technical Progress: Quenching in Bonds



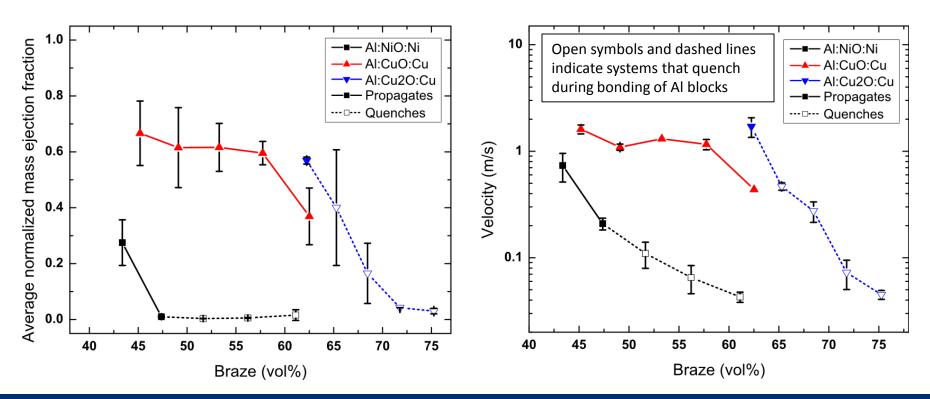
- Large dilutions in NiO and Cu₂O systems lead to quenching in a bond (indicated by open symbols and dashed lines)
- Increase reactivity so foils can still propagate within a bond



Technical Progress: Quenching in Bonds



- Large dilutions in NiO and Cu₂O systems lead to quenching in a bond (indicated by open symbols and dashed lines)
- Increase reactivity so foils can still propagate within a bond
- Larger dilutions will yield larger quantities of braze

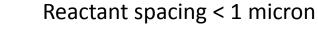


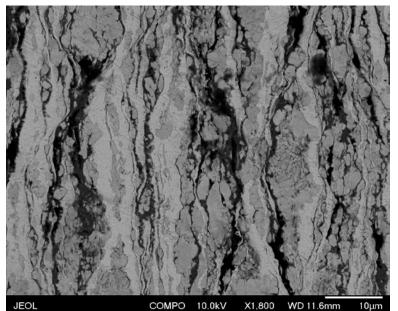
Technical Progress: Enhancing Reactivity

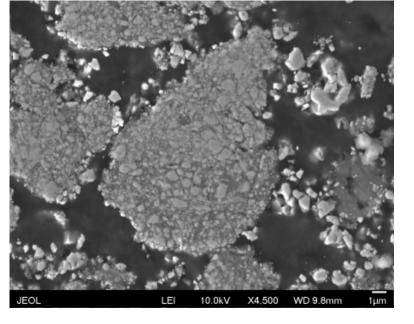
- Decrease reactant spacing via alternative methods (ball milling)
- Incorporate ball milled powder into Redox Foil

Conventional Swaged/Rolled Material

Ball Milled Powder









Response to Previous Year Comments



• This project started in October 1, 2013 but was not reviewed in 2014.

Collaborations

• Severstal – Material supplier

Supplied aluminum-coated boron steel and hot-stamped boron steel for testing

• Dr. Karsten Woll – Former postdoc

Now at Karlsruhe Institute of Technology









Challenge: Mass ejection & large volume fraction of alumina Solution: Increase dilution to minimize ejection and increase braze

Challenge: High dilution can lead to quenching Solution: Decrease average reactant spacing to enhance reactivity

Challenge: Molten braze from Redox reaction wets poorly Solution: Alloy best braze(s) with reactive elements

Challenge: Best braze(s) may lead to corrosion Solution: Alloy braze systems to minimize corrosion

Future Work



- Minimize reactant spacing and enhance reactivity so as to maximize dilution
- Identify optimum dilutions for the NiO and Cu₂O systems
 - wt% dilution as well as chemistry
 - Maximize wetting, minimize ejection
- Identify optimum means for combining diluent with reactive particles.
- Create statistically signification datasets for shear strengths of bonds and determine the modes of failure in the joint.

Summary



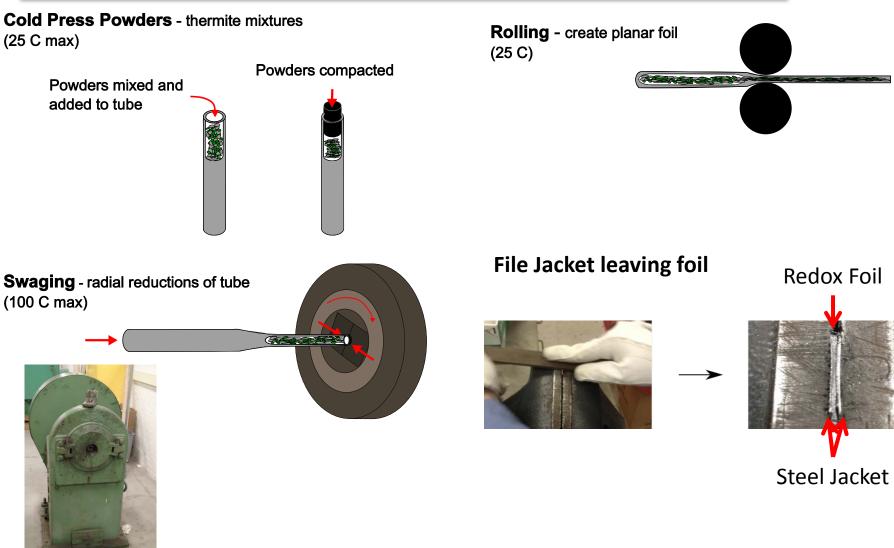
- Several Ni- and Cu-based Redox systems have been fabricated and studied while varying the level of dilution.
 - Velocity and mass ejection decrease with increasing dilution
 - The amount of braze available to the bond increases with dilution
- Preliminary bonding data suggests that moderate bond strengths can be obtained and depend strongly on foil chemistry and the materials being bonded.
- Further microstructural refinement is needed to promote propagation of the Redox reaction through the bond interface in heavily-diluted foils.

Instruction

Technical Back-Up Slides

(Note: please include this "separator" slide if you are including back-up technical slides (maximum of five technical back-up slides). These back-up technical slides will be available for your presentation and will be included in the DVD and Web PDF files released to the public.)

Technical Backup: Fabrication





Technical Backup: Quenching Limits



Mg AZ 31 \bigtriangledown AI 6061 Propagate AI:NiO:Ni Quench No Ignition Mg AZ 31 AI:Cu₂O:Cu AI 6061 AI:CuO:Cu 0 10 20 30 40 50 60 Dilution (wt %)

Quenching Limit



